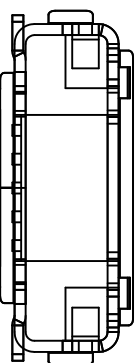
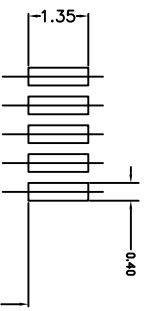
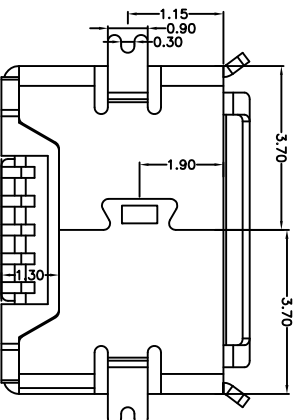
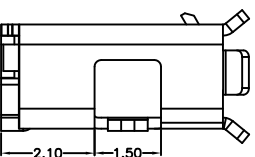
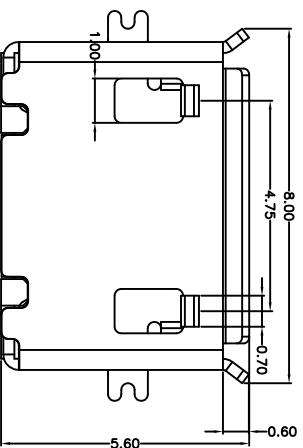
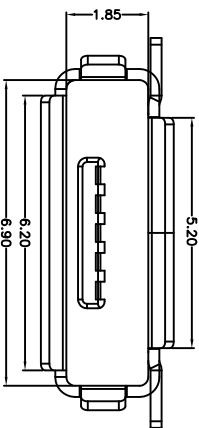
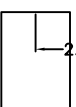


CUSTOMER COPY

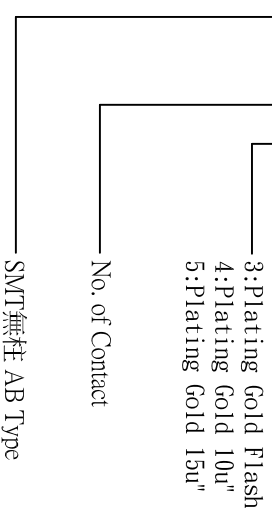


PCB LAYOUT



ORDER INFORMATION

1501 02 00 X X



Material:

- 1.1 Housing:High Hemperative thermoplastic with g.f, UL94V-0
- 1.2 Contact: copper alloy, t=0.20mm
- 1.3 Shell: copper alloy, t=0.25mm
- 2.Specification:
 - 2.1 Current rating: 1 A Max.
 - 2.2 Dielectric withstanding voltage:100 V(ac)for 1 min.
 - 2.3 Contact resistance:50 mΩ Max.
 - 2.4 Insulation resistance: 100 MΩ Min.
 - 2.5 TOTAL mating force:3.57 Kgf Max.
 - 2.6 Totl ubnating force:1.0 Kgf Min. 0.81-2.05 Kgf Min after 10000 Insertion/extration cycles
 - 2.7 Temperature range:-30C-80C



REV.	DESCRIPTION	APP.	DATE
A	NEW DESIGN	Amos	2013-01-02


 钰滿榮企業股份有限公司 ACMELUX CO., LTD.
 TEL:886-2-85124595 FAX:886-2-85124322

0.0±0.30	SCALE: 1:1	TITLE:	PART NO:
0.00±0.20	UNIT: mm	5P SMT Type	APP BY: <i>Stung</i>
0.000±0.1		Micro USB Connector	CHK BY: <i>Cheryl</i>
		MATL: RoHS	DR BY: <i>Amos</i>
		DWG. NO. C15010200XX	A292